APPLICA	BLE STANI	DARD						
OPERATING TEMPERATURE		E RANGE	-45°C TO +125°C(NOTES 1)		RAGE PERATURE RANGE	-10°C TO + 60°C (NOT		2)
RATING	VOLTAGE				LICABLE INECTOR	DF9#-*P-1V(22)		
	CURRENT		0. 5A		INECTOR	DF9#-*P-1V(32)		
			SPECIFICAT	10	NS			
	 ГЕМ		TEST METHOD			UIREMENTS	QT	АТ
	RUCTION							
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING.			Х
MARKING		CONFIRMED VISUALLY.						X
ELECTR	IC CHARA	CTERIS	STICS		<u> </u>		Х	
CONTACT RESISTANCE		100m A (DC OR 1000 Hz).			50mΩ MAX.			_
INSULATION RESISTANCE		100V DC.			500MΩ MIN.			_
VOLTAGE PROOF		250V AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.			_
MECHAN	VICAL CHA	RACT	ERISTICS		•			
MECHANICAL OPERATION		30TIMES INSERTIONS AND EXTRACTIONS.			 CONTACT RESISTANCE: 50mΩ MAX. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 			_
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.			1 NO ELECTRICAL DISCONTINUITY OF 1µs. 2 NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			_
sноск		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			1 NO BLECTRICAL DISCONTINUITY OF 1µs. 2 NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			_
		II OK 3 D	ENVIRONMENTAL CHA	DΛ		K OR LOOSENESS OF PARTS.	Х	
RAPID CHA	NGF OF	TEMPER 4	ATURE -65 \rightarrow 5 TO 35 \rightarrow 125 \rightarrow 5 TO 35°C	NAU		TANCE: 50mΩ MAX.		1
TEMPERATURE		TIME 30→10 TO 15→ 30→10TO15min UNDER 5 CYCLES.			② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			_
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.			① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			_
HEAT RESISTANCE OF SOLDERING		[RECOMMENDED TEMPERATURE PROFILE] «SOLDERING AREA» MAX250°C, 220°C FOR 60 SECONDS MAX. «PREHEATING AREA» 150 TO 180°C 90∼120 SECONDS. MAXIMUM TWICE ACTION IS ALLOWED UNDER THE SAME CONDITION. [RECOMMENDED MANUAL SOLDELING CONDITION] SOLDERING IRON TEMPERATURE 380°C SOLDERING TIME: WITHIN 3 SECONDS.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.			_	
SOLDERABILITY		DURATIO	SOLDERING TEMPARATURE:245±5°C DURATION OF IMMERSION: SOLDERING FOR 3SECONDS		A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95% OF THE SURFACE BEING IMMERSED.			_
REMARKS								

REMARKS
NOTE1:INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE2:STORAGEIS DEFINED AS LONG-TERM STORAGE OF UNUSED PRODUCTS.

APPLY OPERATION TEMPERATURE RANGE TO PRODUCTS MOUNTED ON PCB WITHOUT POWER SUPLLY.

UNLESS OTHERWISE SPECIFIED , REFER TO JIS C 5402 .

	COUNT	T DESCRIPTION OF REVISIONS		DESIGNED			CHECKED		DATE	
	1	DIS-H-001214		AR. TAKAHASHI		TS.MIYAZAKI		06.	06. 08. 02	
							MO. NAKAMURA	05.	05. 10. 31	
							TS.MIYAZAKI	05.	10. 31	
							TY. 00 I 05		05. 10. 31	
						ΛN	HK. MURAKAMI 05		10. 31	
Note	e QT:Qu	alification Test AT:Assurance Test X:Applicable Tes	st	DRAWIN	IG NO.		ELC4-162417-04			
		SPECIFICATION SHEET		PART NO.		DF9A-*S-1V(22)				
		HIROSE ELECTRIC CO., LTD.		CODE NO.		CL540		Δ	1/1	